U.S. PTO 12/583214 08/17/2009

RECORDATION FORM COVE

Form PTO-1595 (Rev. 09/ 04) OMB No. 0651-0027 (exp. 6/30/2005)

08-26-2009



ERCE Office

PATENTS ONL 103571883	
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.	
Name of conveying party(ies)/Execution Date(s):     KEITA TANAKA	2. Name and address of receiving party(les)
	Name: SONY CORPORATION Internal Address:
Execution Date(s): October 17, 2006  Additional name(s) of conveying party(les) attached? Yes X No  3. Nature of Conveyance:	Street Address: 1-7-1 Konan, Minato-ku Tokyo
X Assignment	108-0075 JAPAN City:
Government Interest Assignment	State:
Executive Order 9424, Confirmatory License  Other	Country: Zip:  Additional name(s) & address(es) Yes X No attached:
4. Application or patent number(s):  A. Patent Application No.(s)  This application	This document is being filed together with a new application.  B. Patent No.(s)
Additional numbers attached?	Yes X No
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Davy E. Zoneraich LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Atty. Dkt.:	Authorized to be charged by credit card
Street Address: 600 South Avenue West	X Authorized to be charged to deposit account     Enclosed     None required (government interest not affecting title)
City: Westfield	8. Payment Information
State: NJ Zip: 07090  Phone Number: (908) 518-6355	a. Credit Card Last 4 Numbers Expiration Date
Fax Number: (908) 654-0415 Email Address: dzoneraich@ldlkm.com	b. Deposit Account Number 12-1095 Authorized User Name Davy E. Zoneraich
9. Signature: Signature	August 17, 2009
Davy E. Zoneraich - 37,267	08/25/2009 DBYRNE 00000002 121995 12583214 Total number of pages including cover 3
Name of Person Signing	81 FOrthoot attachments and Dacuments:

## **ASSIGNMENT**

Docket Number: SONYJP 3.0-665 Sony Ref. No.:S06P1579US00

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

## **OPTICAL ELEMENT**

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, my entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 11/509,150, Filing Date: August 24, 2006.

This assignment executed on the dates indicated below.

PATENT

REEL: 023137 FRAME: 0280

	Docket Number: SONYJP 3.0-665 Sony Ref No.: S06P1579US00
Keita Tanaka Name of First or Sole Inventor	Execution Date of U.S. Patent Application
Name of First of Sole inventor	Execution Date of O.S. Fatent Application
Aichi, Japan Residence of First or Sole Inventor	
Unto Tanaka	n+1 = 10 = 1
	October 17. 2006
Signature of First or Sole Inventor	Date of this Assignment
Name of Second Joint Inventor	Execution Date of U.S. Patent Application
Residence of Second Joint Inventor	
Signature of Second Joint Inventor	Date of this Assignment
Name of Third Joint Inventor	Execution Date of U.S. Patent Application
Residence of Third Joint Inventor	
Signature of Third Joint Inventor	Date of this Assignment
Name of Fourth Joint Inventor	Execution Date of U.S. Patent Application
Residence of Fourth Joint Inventor	
Signature of Fourth Joint Inventor	Date of this Assignment

PATENT REEL: 023137 FRAME: 0281

**RECORDED: 08/17/2009**